# 250W, 28V High Power RF LDMOS FETs

### **Description**

The MK0525 is a 250-watt, highly rugged, unmatched LDMOS FET, designed for wide-band commercial and industrial applications with frequencies HF to 1 GHz. It can be used in Class AB/B and Class C for all typical modulation formats.

•Typical Performance (On Innogration fixture with device soldered):

 $V_{DD}$  = 28 Volts,  $I_{DQ}$  = 1200 mA, CW.

Frequency	Gp (dB)	P <sub>-1dB</sub> (W)	η <sub>D</sub> @P <sub>-1</sub> (%)	
1000 MHz	17	250	60	

•Typical Performance (On Innogration fixture with device soldered):

 $V_{DD}$  = 28 Volts,  $I_{DQ}$  = 1500 mA, CW.

Freq(MHz)	Gain ( dB )	P-1(W)	Eff(%)
30	18.9	107	57.5
100	19.3	204	56.5
150	18.6	195	56.6
200	18.5	166	52.5
250	250 18.9 141		51.5
300	18.8	159	54.5
350	19.1	166	55.6
400	19.1	155	51.7
450	19.4	170	51.0
512	20.6	170	51.7

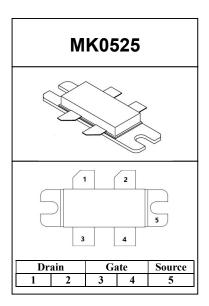


Figure 1. Pin Connection

• Typical Performance (In Demo Fixture): Pout= 40 Watts @ 30 MHz-512 MHz,

 $V_{DD}$  = 28 Volts,  $I_{DQ}$  = 1.5 A, Two tone space 100KHz.

Freq(MHz)	30	100	200	300	400	512
IMD3(dBc)	-38	-37	-33	-37	-39	-36

#### **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

## Suitable Applications

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz 1000MHz (ISM, instrumentation)

**Table 1. Maximum Ratings** 

# **MK0525 LDMOS TRANSISTOR**

Document Number: MK0525 Product Datasheet V2.0

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+95	Vdc
GateSource Voltage	$V_{GS}$	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+40	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T,	+225	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	0.32	°C AM
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C, DC test	Keac	0.32	°C/W

#### **Table 3. ESD Protection Characteristics**

Test Methodology	Class		
Human Body Model (per JESD22A114)	Class 2		

## 

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics (per half section)					
Drain-Source Voltage	V	90			V
V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA	V <sub>(BR)DSS</sub>	90			v
Zero Gate Voltage Drain Leakage Current				1	
$(V_{DS} = 75V, V_{GS} = 0 V)$	I <sub>DSS</sub>			I	μΑ
Zero Gate Voltage Drain Leakage Current				1	
$(V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V})$	I <sub>DSS</sub>			'	μΑ
GateSource Leakage Current				1	
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	I <sub>GSS</sub>			ı	μΑ
Gate Threshold Voltage	V <sub>GS</sub> (th)		2.15		V
$(V_{DS} = 28V, I_D = 650 \mu A)$	V GS(U1)		2.13		V
Gate Quiescent Voltage	$V_{GS(Q)}$		3.2		V
(V <sub>DD</sub> = 28 V, I <sub>D</sub> = 1.5 A, Measured in Functional Test)	V GS(Q)		5.2		V
Common Source Input Capacitance	C <sub>ISS</sub>		128		pF
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	Oiss		120		ρι
Common Source Output Capacitance	Coss		43		nE
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	Coss		43		pF
Common Source Feedback Capacitance	C <sub>RSS</sub>		2.4		nE
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	CRSS		2.4		pF

### Functional Tests (In Demo Test Fixture, 50 ohm system) $V_{DD}$ = 28 Vdc, $I_{DQ}$ = 1200 mA, f = 1000 MHz, CW Signal Measurements.

• ,		•	
Power Gain	Gp	 17	 dB
Drain Efficiency@P1dB	η <sub>D</sub>	 60	 %
1 dB Compression Point	P <sub>-1dB</sub>	 250	 W
Input Return Loss	IRL	 -7	 dB

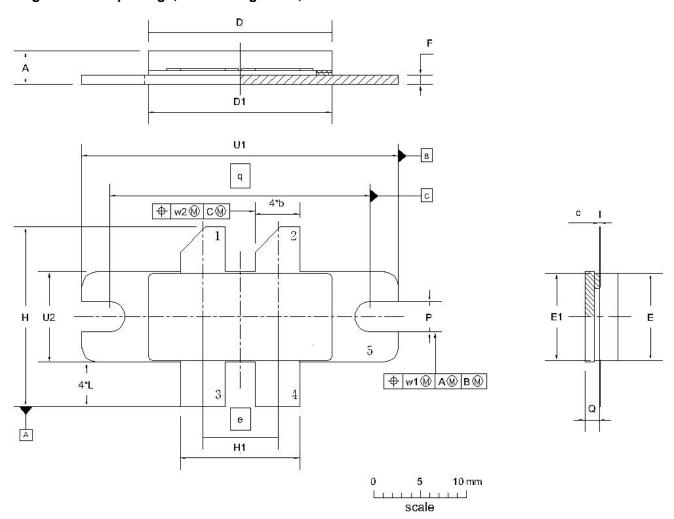
Load Mismatch (In Innogration Test Fixture, 50 ohm system): V<sub>DD</sub> = 28 Vdc, I<sub>DQ</sub> = 1200 mA, f = 1000 MHz

VSWR 20:1 at 250W pulse CW Output Power	No Device Degradation
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# **MK0525 LDMOS TRANSISTOR**

# **Package Outline**

## Flanged ceramic package; 2 mounting holes; 4 leads



UNIT	A	b	С	D	D <sub>1</sub>	е	E	E <sub>1</sub>	F	Н	H1	L	p	Q	q	U <sub>1</sub>	U <sub>2</sub>	W <sub>1</sub>	W <sub>2</sub>
mm	4.72	3.94	0.15	20.02	19.96	8.89	9.50	9.53	1.14	19.94	12.83	5.33	3.38	1.70	27.94	34.16	9.91	0.25	0.51
	3.43	3.68	0.08	19.61	19.66	0.09	9.30	9.25	0.89	18.92	12.57	4.32	3.12	1.45	27.54	33.91	9.65	0.20	0.01
inches	0.186	0.155	0.006	0.788	0.786	0.25	0.374	0.375	0.045	0.785	0.505	0.210	0.133	0.067	1 100	1.345	0.390	0.01	0.00
inches	0.135	0.145	0.003	0.772	0.774	0.35	0.366	0.364	0.035	0.745	0.495	0.170	0.123	0.057	1.100	1.335	0.380	0.01	0.02

OUTLINE		REFERENCE		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	1000E DATE
PKG-B4E					03/12/2013

# MK0525 LDMOS TRANSISTOR

Document Number: MK0525 Product Datasheet V2.0

#### **Revision history**

#### Table 5. Document revision history

Date	Revision	Datasheet Status
2016/8/8	Rev 1.0	Preliminary Datasheet
2017/2/22	Rev 2.0	Product Datasheet

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